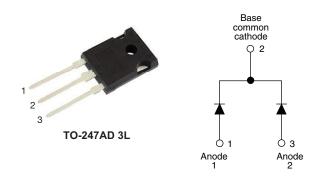


Hyperfast Soft Recovery Diode, 2 x 15 A FRED Pt[®] Gen 4



PRIMARY CHARACTERISTICS						
I _{F(AV)}	2 x 15 A					
V _R	600 V					
V _F at I _F	1.28 V					
t _{rr} typ.	See Recovery table					
T _J max.	175 °C					
Package	TO-247AD 3L					
Circuit configuration	Common cathode					

FEATURES

- Gen 4 FRED Pt® technology
- Low I_{RRM} and reverse recovery charge
- · Very low forward voltage drop
- Polyimide passivated chip for high reliability standard



- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

DESCRIPTION

Gen 4 Fred technology, state of the art, ultralow V_{F} , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Peak repetitive reverse voltage	V_{RRM}		600	V			
Average rectified forward current	I _{F(AV)}	T _C = 142 °C	15	۸			
Non-repetitive peak surge current, per leg	I _{FSM}	$T_C = 25$ °C, $t_p = 8.3$ ms, half sine wave	200	A			
Operating junction and storage temperature	T _J , T _{Stg}		-55 to +175	°C			

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	600	-	-		
Forward voltage		I _F = 15 A	-	1.6	1.9	V	
	V _F	I _F = 30 A	-	1.87	-		
		I _F = 15 A, T _J = 125 °C	-	1.35	-		
		I _F = 30 A, T _J = 125 °C	-	1.67	-		
		I _F = 15 A, T _J = 150 °C	-	1.28	1.52		
		I _F = 30 A, T _J = 150 °C	-	1.61	-		
Developed to the control of the cont		V _R = V _R rated	-	-	15		
Reverse leakage current	I _R	T _J = 125 °C, V _R = V _R rated	-	-	500	μA	
Junction capacitance	C _T	V _R = 600 V	-	16	-	pF	



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS MIN. TYP. MAX.						
Reverse recovery time		T _J = 25 °C		-	50	-	ns	
	t _{rr}	T _J = 125 °C	$I_F = 15 \text{ A}$ $dI_F/dt = 1000 \text{ A/}\mu\text{s}$ $V_R = 400 \text{ V}$	-	70	-		
Dook recovery ourrent	I _{RRM}	T _J = 25 °C		-	8.5	-	A	
Peak recovery current		T _J = 125 °C		-	16	-		
Reverse recovery charge	Q _{rr}	T _J = 25 °C		-	250	-	nC	
		T _J = 125 °C		-	600	-		

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction to case	R_{thJC}		-	-	1.4		
Thermal resistance, junction to ambient	R_{thJA}	Typical socket mount	-	-	40	°C/W	
Thermal resistance, case to heat sink	R _{thCS}		-	0.4	-		
Weight			-	6.0	-	g	
vveignit			-	0.21	-	oz.	
Mounting torque			6.0 (5)	-	12 (10)	kgf · cm (lbf · in)	
Marking device		Case style TO-247AD 3L	C4PH3006L				

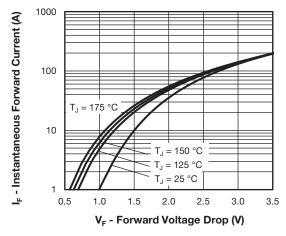


Fig. 1 - Typical Forward Voltage Drop Characteristics

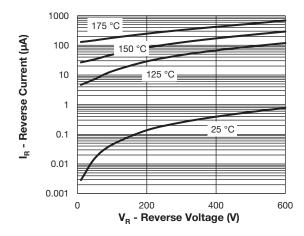


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

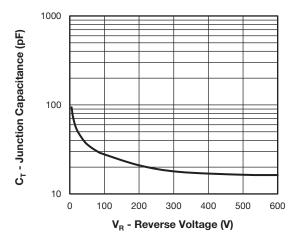


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

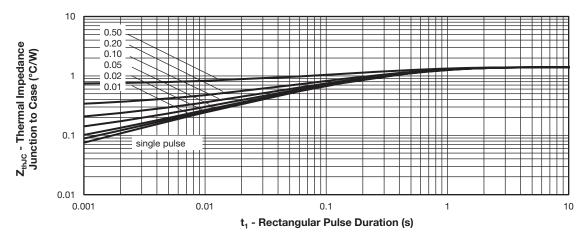


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

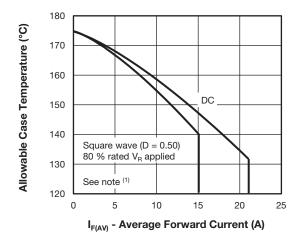


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

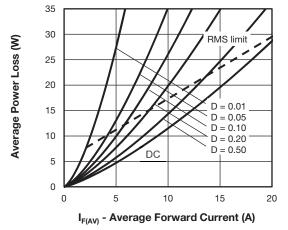


Fig. 6 - Forward Power Loss Characteristics

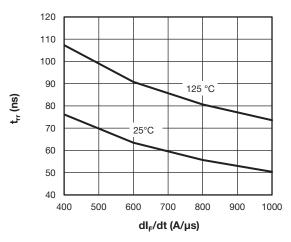
Note

⁽¹⁾ Formula used: T_C = T_J - (P_d + P_{dREV}) x R_{thJC}; Pd = forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see Fig.5) P_{dREV} = inverse power loss = V_{R1} x I_R (1 - D); I_R at V_R = rated V_R



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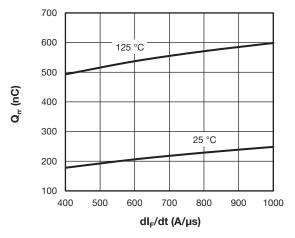


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

Fig. 8 - Typical Stored Charge vs. dl_F/dt

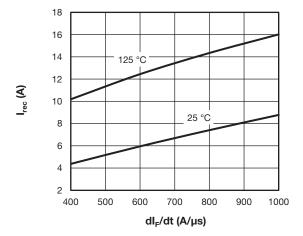
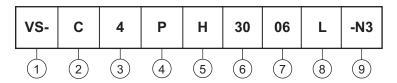


Fig. 9 - Typical Reverse Current vs. dl_F/dt



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration:

C = common cathode

FRED Pt Gen 4

4 - P = TO-247 package

5 - Process type:

H = hyperfast recovery

6 - Current rating (30 = 2 x 15 A)

7 - Voltage rating (06 = 600 V)

8 - Package: L = long lead

9 - Environmental digit:

-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

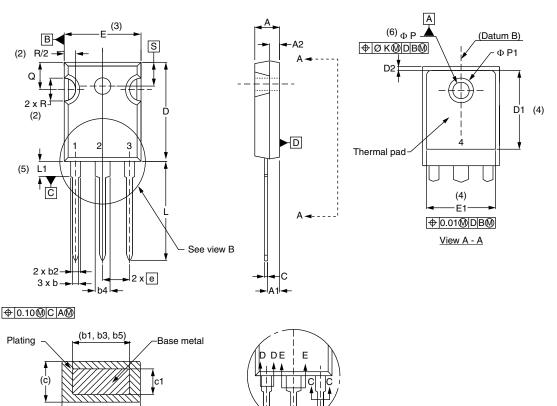
ORDERING INFORMATION (Example)						
PREFERRED P/N QUANTITY PER TUBE MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION						
VS-C4PH3006L-N3	25	500	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95626				
Part marking information	www.vishay.com/doc?95007				



TO-247AD 3L

DIMENSIONS in millimeters and inches



View B

0)/14001	MILLIN	MILLIMETERS		INCHES		
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.65	5.31	0.183	0.209		
A1	2.21	2.59	0.087	0.102		
A2	1.50	2.49	0.059	0.098		
b	0.99	1.40	0.039	0.055		
b1	0.99	1.35	0.039	0.053		
b2	1.65	2.39	0.065	0.094		
b3	1.65	2.34	0.065	0.092		
b4	2.59	3.43	0.102	0.135		
b5	2.59	3.38	0.102	0.133		
С	0.38	0.89	0.015	0.035		
c1	0.38	0.84	0.015	0.033		
D	19.71	20.70	0.776	0.815	3	
D1	13.08	-	0.515	-	4	

Section C - C, D - D, E - E

SYMBOL	MILLIMETERS		INC	NOTES	
STMIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØΚ	0.254		0.010		
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217	BSC	
		•	•		

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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